



2.4/5GHz双频1x1 Wi-Fi® 4 (802.11n) + Bluetooth® 5.2解决方案

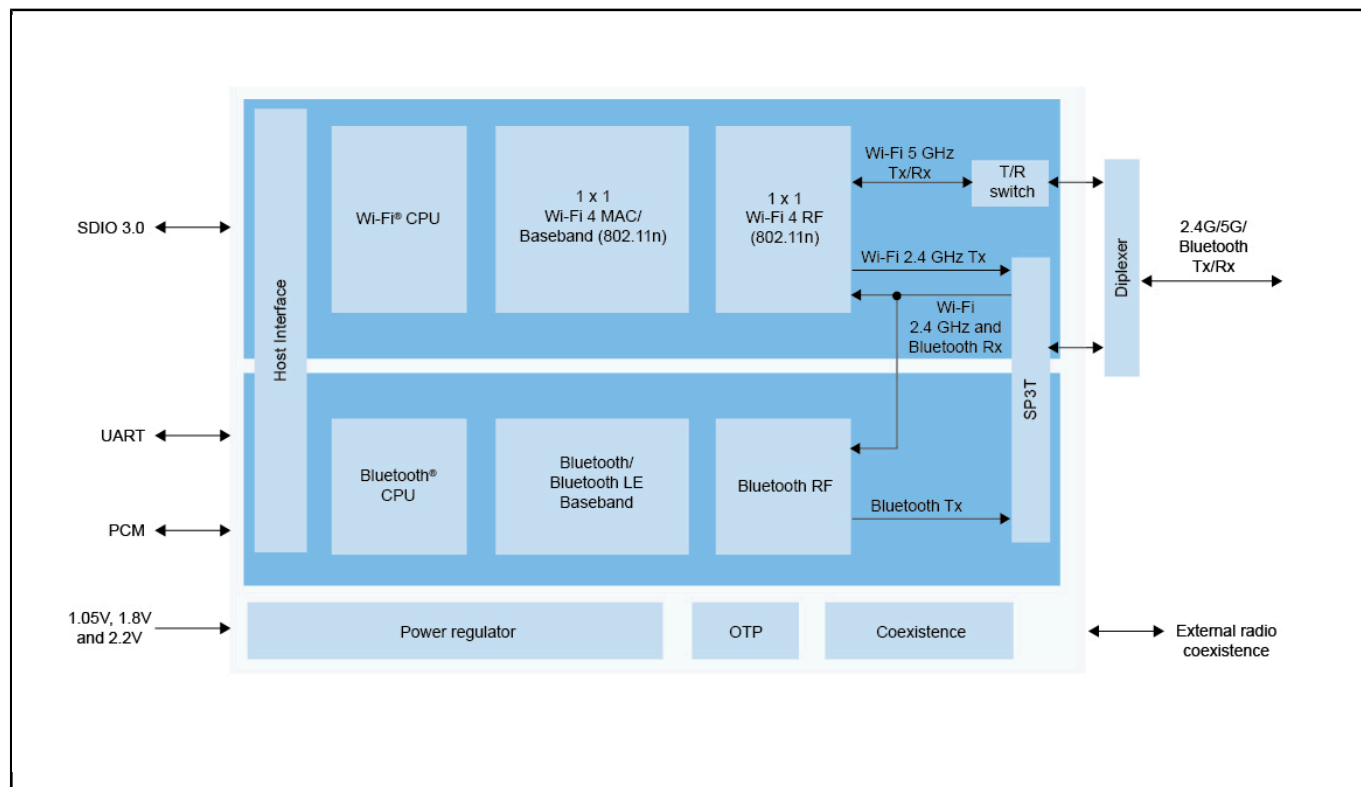
88W8977

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88W8977片上系统(SoC)是一个高度集成的单芯片解决方案，融合了Wi-Fi (2.4/5GHz)和蓝牙技术。符合IEEE 802.11n的双频片上系统可提供高达MCS 7 (150Mbit/s)的Wi-Fi数据传输速率。SoC专用于支持可穿戴设备、物联网(IoT)和智能家居应用等设备的速度、可靠性和质量要求。Combo解决方案提供了符合IEEE 802.11n的1x1空间流和Bluetooth 5.2的同时操作和独立操作，具有高速和网状网，可以增强物联网(IoT)功能。

领先的模块制造商提供提供基于恩智浦88W8977的无线模块。

88W8977框图 Block Diagram



View additional information for [2.4/5GHz双频1x1 Wi-Fi® 4 \(802.11n\) + Bluetooth® 5.2解决方案](#).

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